

# HSF RoHS

NOTE:

1. Material:

Housing: LCP Black;Thermoplastics,UL94V-0(Halogen free)  
 Contact: Copper Alloy  
 Shell: Copper Alloy  
 Back Shell: Ferro Alloy

2. FINISH:

Contact: Gold Flash Plated on Contact Area,  
 80u" Min.Tin Plated on Solder Tails,  
 50u" Min.Nickel Underplating Over All.  
 Shell: 50u" Min.Nickel Underplating Over All.

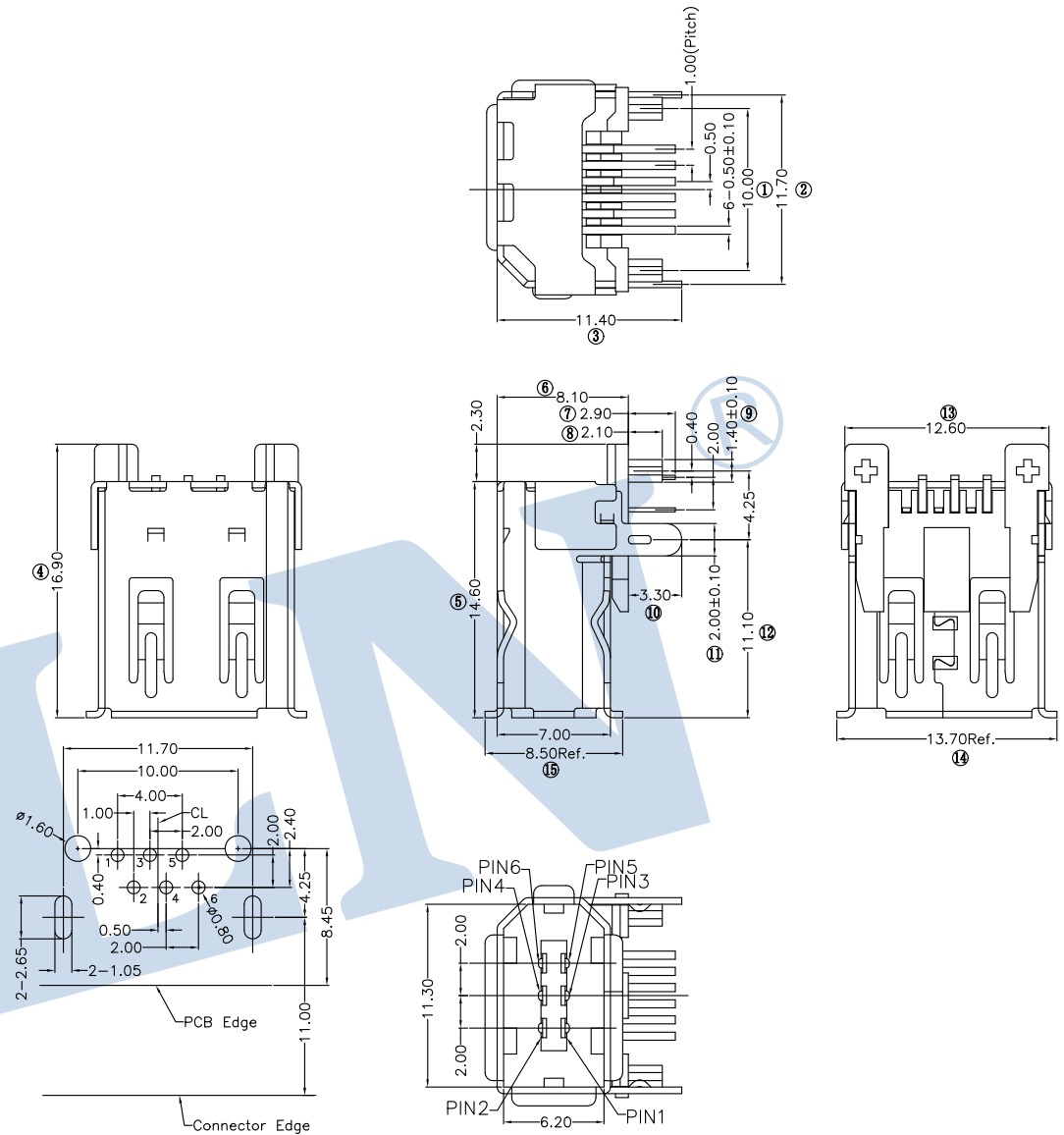
3. Specification:

3.1: Rating:

Rated voltage:40V AC/DC. Rated current: 1.5 A Max.

3.2: Electrical:

Insulation Resistance: 100MΩ Min  
 Contact Resistance: 30 mΩ Max  
 Dielectric Withstanding Voltage: 500V/AC



RECOMMENDED PCB LAYOUT(TOP VIEW)  
 GENERAL TOLERANCES:±0.05

				OPERATION		DRAW	yiyusheng	14.03.28	SCALE	FIT	<b>JILN</b> ® 深圳市锦凌电子有限公司	
				X.X	±0.30				UNIT	mm	SHENZHEN JINLING ELECTRONICS CO.,LTD	
				X.XX	±0.20	CHECK			SIZE	A4	Tel: 86-755-27483253 Fax: 86-755-2997-5588	
A0	2014.03.28	NEW DRAWING		X.XXX	±0.10				SHEET	1/1	PART NO.	6312M-06RS0MA02
REV	DATE	MODIFICATION DESCRIPTION		Angle	±3°	APPROVE			PROJ.	☯	TITLE:	1394 6F 90° 反侧插 铜黑
			CHANGE	DIM	TOL							